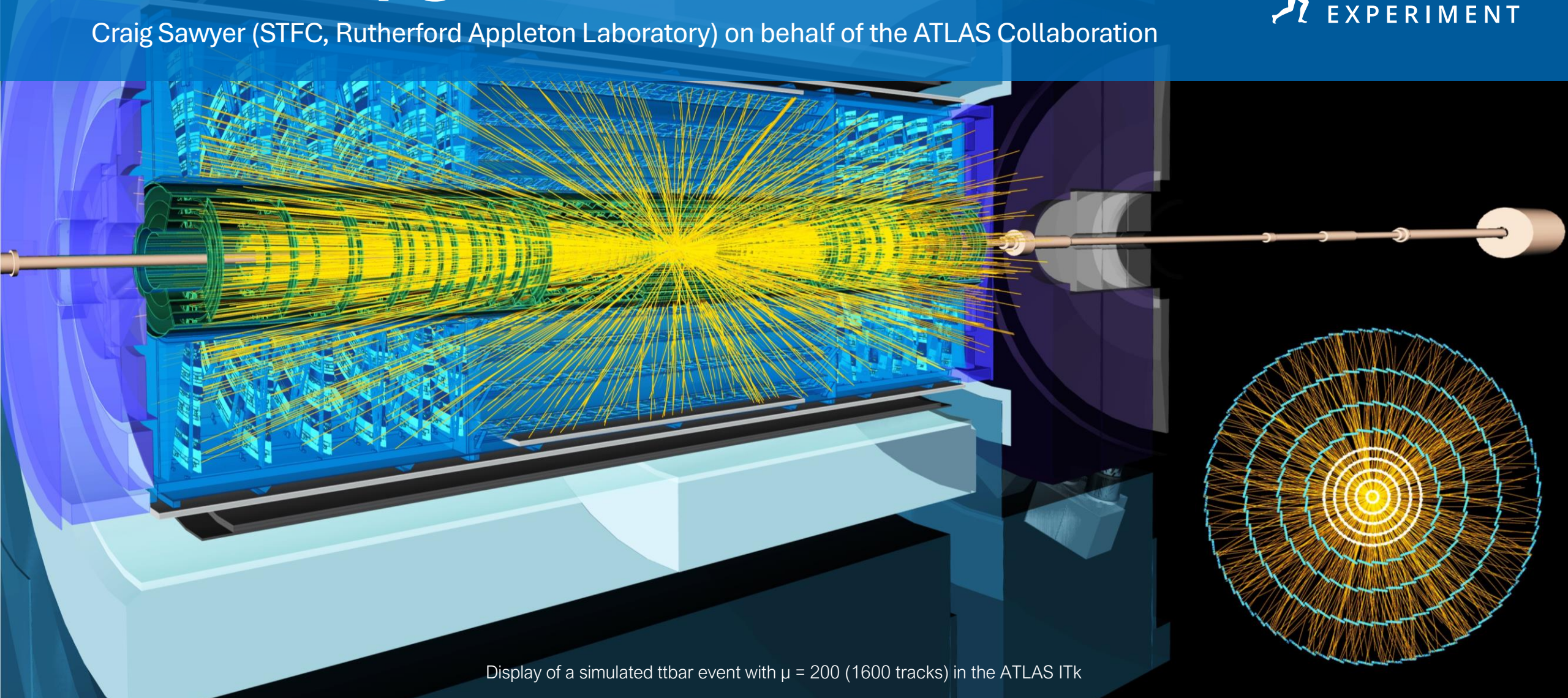


# ATLAS Upgrades and Plans

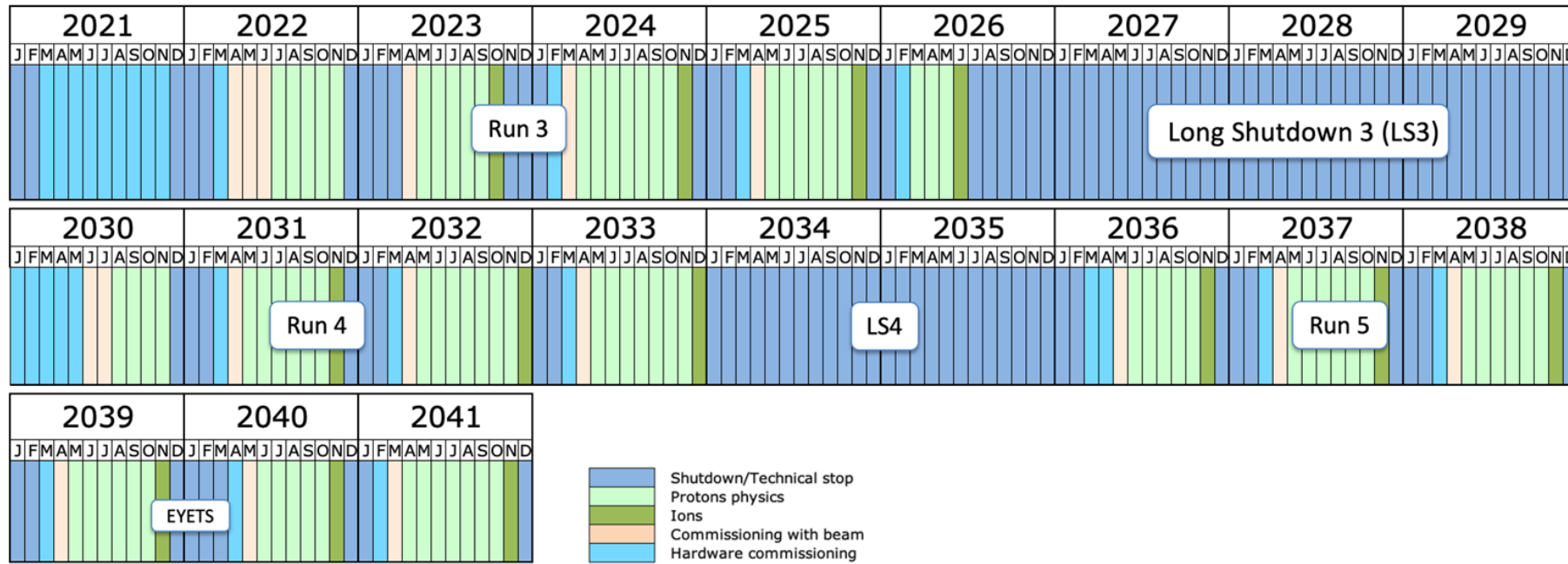
Craig Sawyer (STFC, Rutherford Appleton Laboratory) on behalf of the ATLAS Collaboration



Display of a simulated  $t\bar{t}$  event with  $\mu = 200$  (1600 tracks) in the ATLAS ITk

# High Luminosity LHC

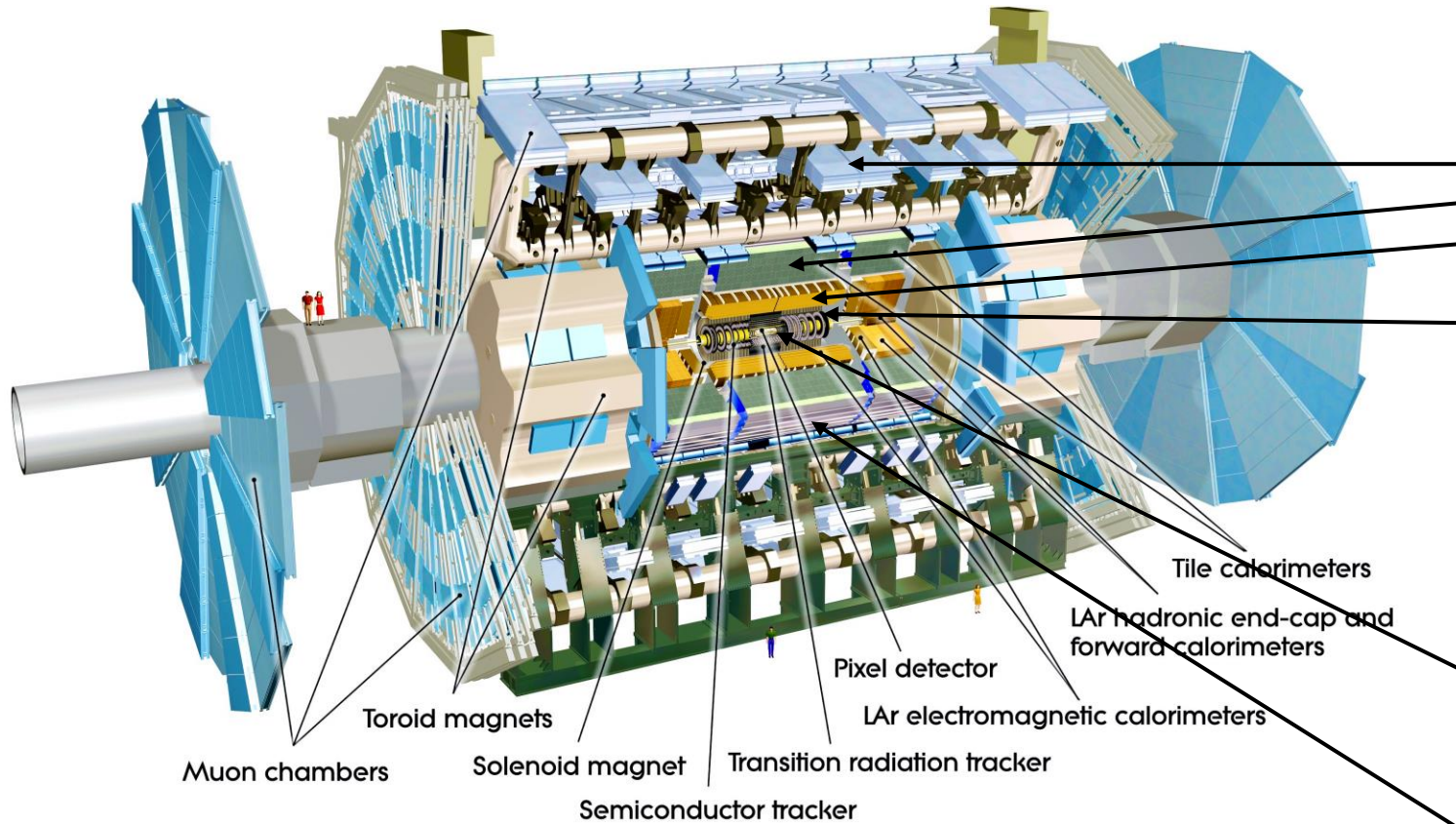
- Higgs factory (350M Higgs bosons produced) for precise Higgs coupling measurements, access to Higgs self-interaction and longitudinal vector boson scattering, and increased overall rare & new physics sensitivity
- Unique physics opportunities for many decades, in many ways complementary to an FCC-ee HET Factory
- The HL-LHC's luminosity requires unprecedented detector and computing technologies and thus significant experiment upgrades



Last update: November 24



# ATLAS Phase-II Upgrade



## Upgraded Trigger and Data Acquisition System

Level-0 Trigger at 1 MHz  
Improved High-Level Trigger  
150 kHz full-scan tracking

## Electronics Upgrades

Muon System  
Tile Calorimeter  
LAr Calorimeter

## High Granularity Timing Detector (HGTD)

Forward region ( $2.4 < |\eta| < 4.0$ )  
Low-Gain Avalanche Detectors (LGADs) with 30 ps track resolution

## Additional small upgrades

Luminosity detectors (1% precision goal)  
HL-ZDC

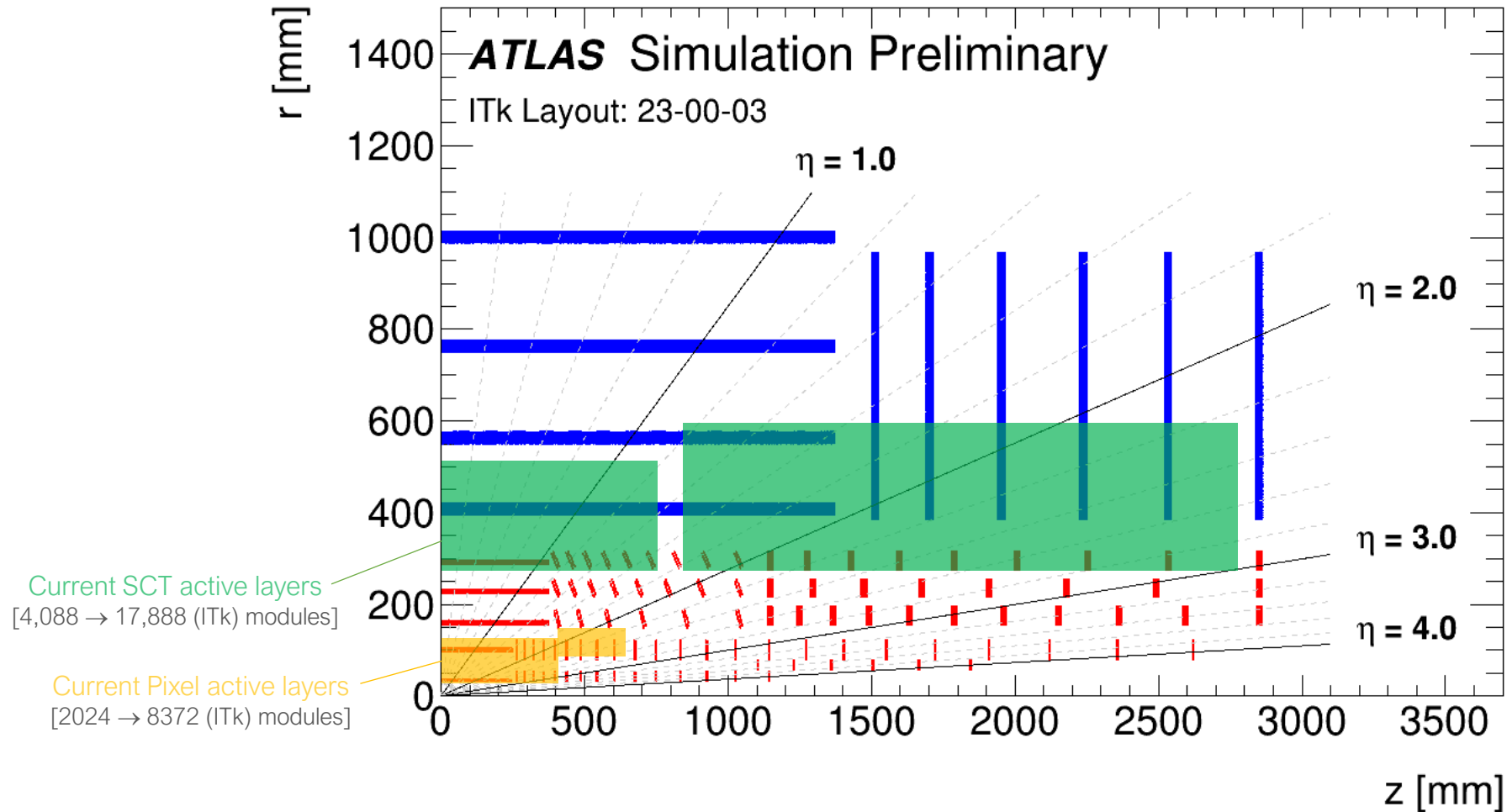
## New Inner Tracking Detector (ITk)

All silicon  
Coverage up to  $|\eta| = 4$

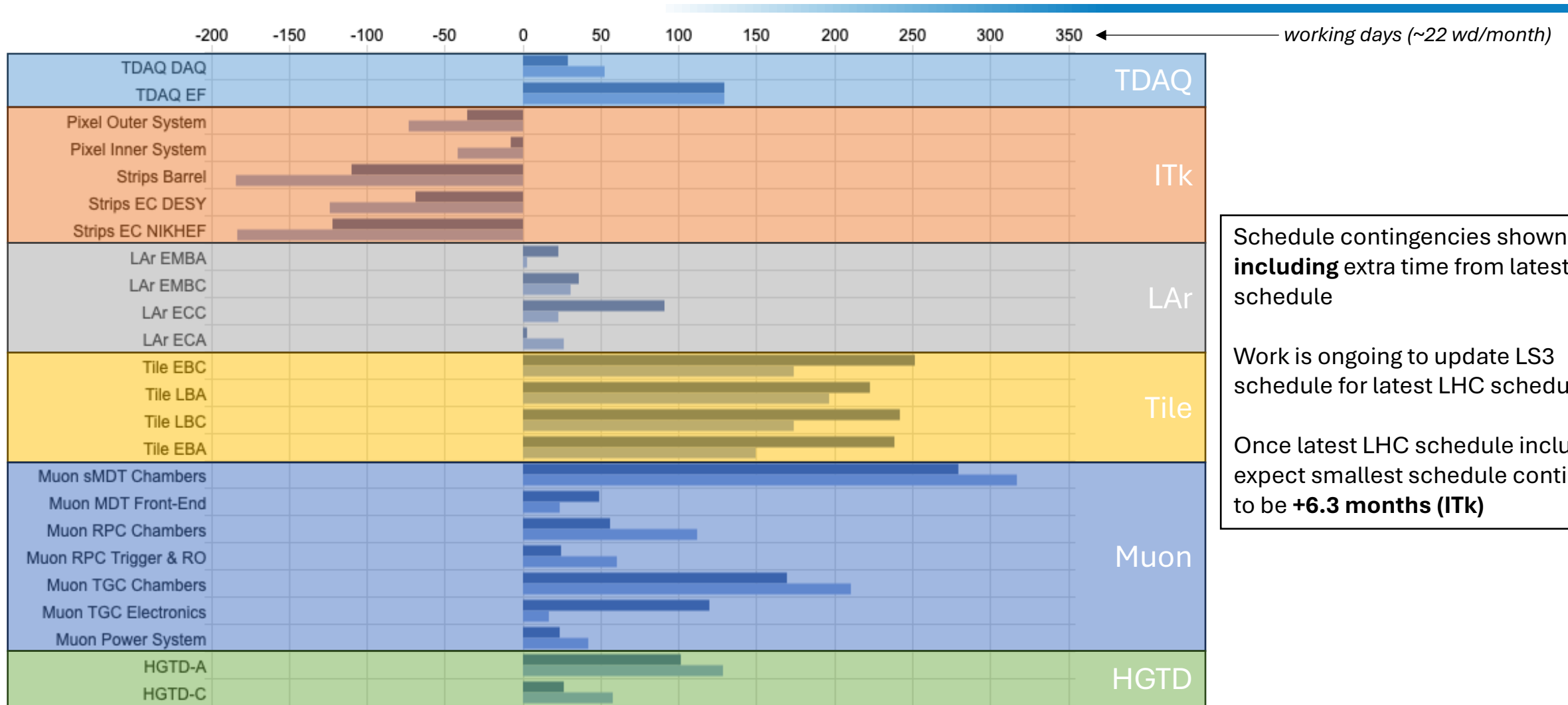
## New Muon Chambers

Inner barrel region with new RPC and sMDT detectors

# ATLAS Phase-II Upgrade – Inner Tracker



# Schedule Contingency Summary



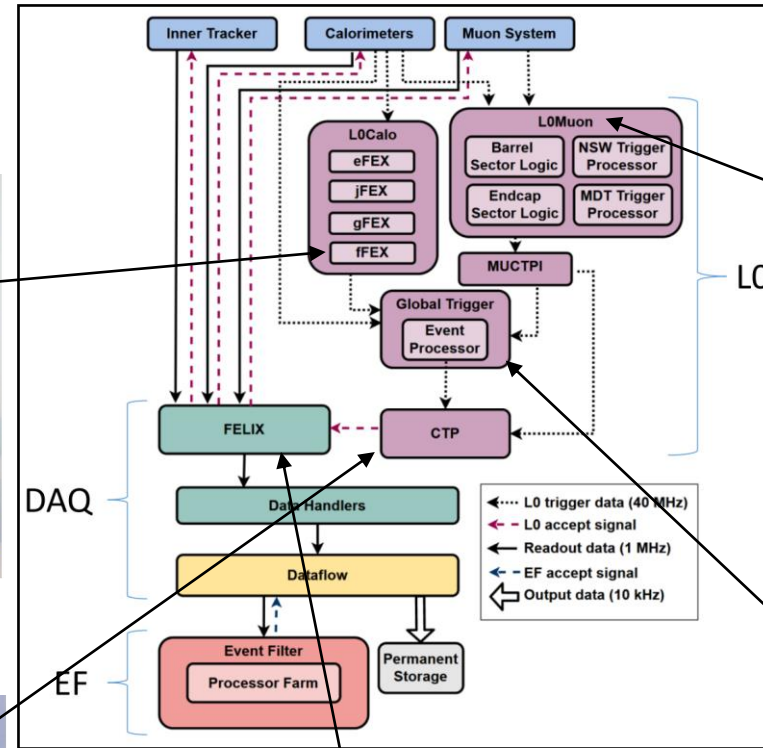
Schedule contingencies shown **not including** extra time from latest LHC schedule

Work is ongoing to update LS3 schedule for latest LHC schedule

Once latest LHC schedule included expect smallest schedule contingency to be **+6.3 months (ITk)**

# TDAQ

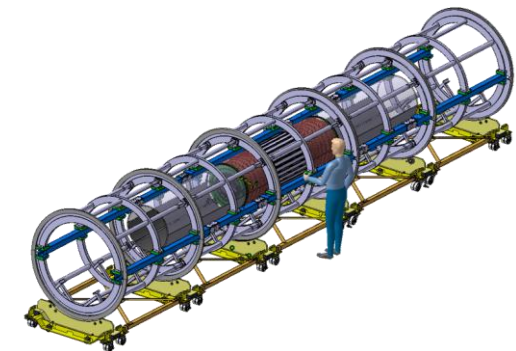
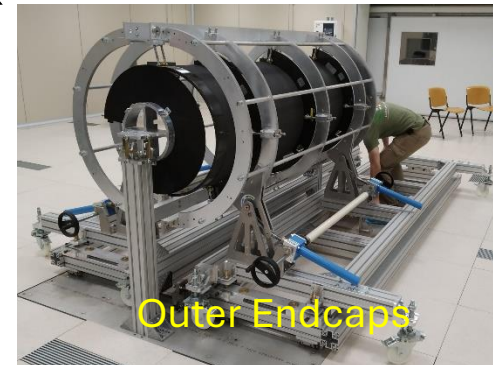
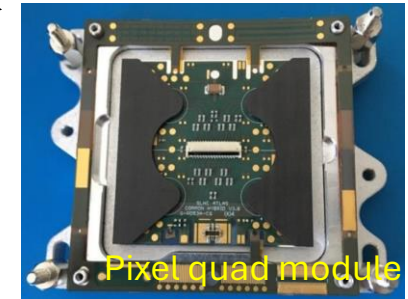
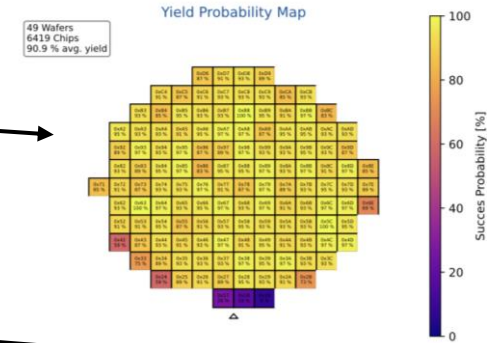
- Three major project areas
  - L0 Trigger
    - Low latency FPGA-based global trigger enabling complex event selections
  - DAQ
    - Readout, data handling, dataflow
  - Event filter (EF)
    - High level event selection
- Excellent progress in many areas
  - LTI, fFEX and GCM prototypes all received recently
  - Prototype DAQ boards received at CERN (FLX-182), first sample of production candidate card (FLX-155) tested
  - Proceeding towards EF technology choice through 2025





# ITk Pixel

- Pixel production starting
  - Sensors and ASIC production progressing well
  - Production hybridisation started with 2/4 vendors
  - Two stage Production Readiness Review (PRR) for module assembly
    - First stage completed in July, second stage scheduled in November
  - Outer system local supports ongoing
- Tooling for integration etc. coming together nicely



Area	PDR	Prototyping	FDR	Preproduction	PRR	Production
Planar Si sensors	Complete	Complete	Complete	Complete	Complete	Complete
3D Si Sensors	Complete	Complete	Complete	Complete	Complete	Complete
FE-ASIC	Complete	Complete	Complete	Complete	Complete	Complete
Hybridization	Complete	Complete	Complete	Complete	Ongoing	Ongoing
Module Assembly	Complete	Complete	Complete	Complete	Ongoing	Ongoing
On-detector Services	Complete	Complete	Complete	Complete	Ongoing	Ongoing
Off-detector Services	Complete	Complete	Complete	Complete	Ongoing	Ongoing
Data Transmission	Complete	Complete	Complete	Complete	Ongoing	Ongoing
Bare Local Supports	Complete	Complete	Complete	Complete	Ongoing	Ongoing
Loaded Local Supports	Complete	Complete	Complete	Complete	Ongoing	Ongoing
Global Mechanics	Complete	Complete	Complete	Complete	Ongoing	Ongoing
Integration	Complete	Complete	Complete	Complete	Ongoing	Ongoing
Power Supplies	Complete	Complete	Complete	Complete	Ongoing	Ongoing

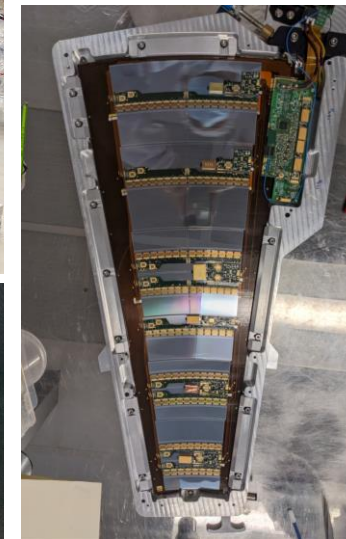
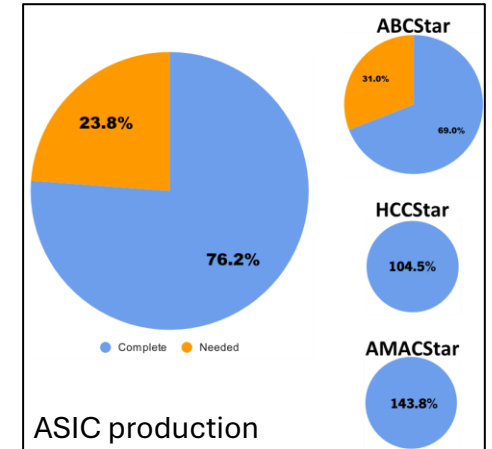
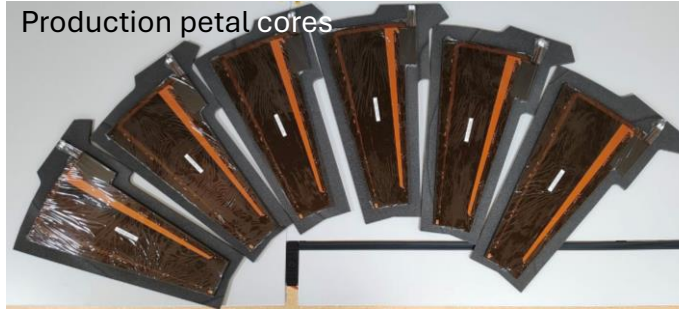
■ Complete   
 ■ Ongoing   
 ■ Upcoming

# ITk Strip

- Many areas well into production
  - Sensors, ASICs, EoS, EoS-DCDC, bus-tapes, cores, common mechanics, service modules
- Module production on hold since May 2022 due to two major technical issues
- Currently building final prototypes validating solutions
  - Expect to start module production in early 2025
- Global mechanics being produced
  - 2 ECs, L3 and L2 all assembled

Area	PDR	Prototyping	FDR	Preproduction	PRR	Production
Sensors	Complete	Complete	Complete	Complete	Complete	Complete
ASICs	Complete	Complete	Complete	Complete	Complete	Complete
Modules	Complete	Complete	Complete	Complete	Ongoing	Upcoming
EoS	Complete	Complete	Complete	Complete	Complete	Complete
EoS-DCDC	Complete	Complete	Complete	Complete	Complete	Complete
Cores (B)	Complete	Complete	Complete	Complete	Complete	Complete
Cores (EC)	Complete	Complete	Complete	Complete	Complete	Complete
Module mounting	Complete	Complete	Complete	Complete	Ongoing	Upcoming
Global Mechanics	Complete	Complete	Complete	Complete	Complete	Complete
Services (on-detector)	Complete	Complete	Complete	Complete	Complete	Complete
Services (off-detector)	Complete	Complete	Complete	Complete	Ongoing	Upcoming
Power Supplies	Complete	Complete	Complete	Complete	Ongoing	Upcoming

■ Complete   
 ■ Ongoing   
 ■ Upcoming

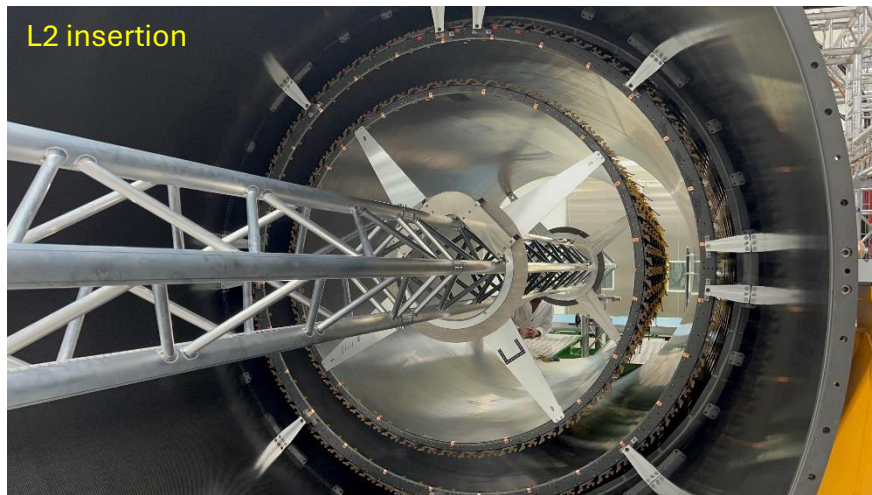


Recent prototype stave/petal



# ITk Common

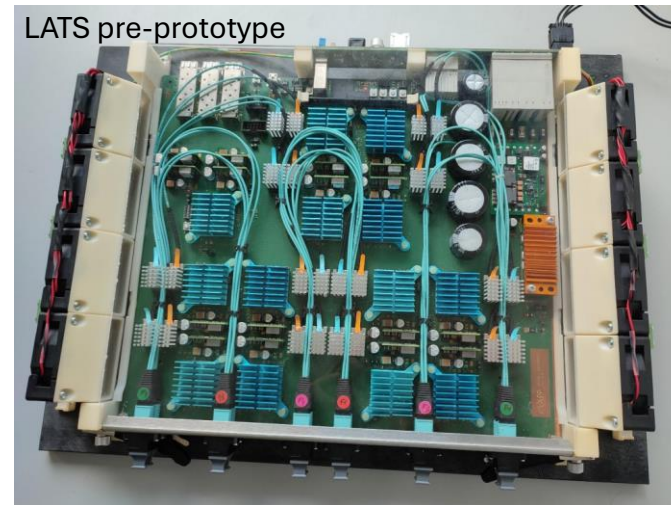
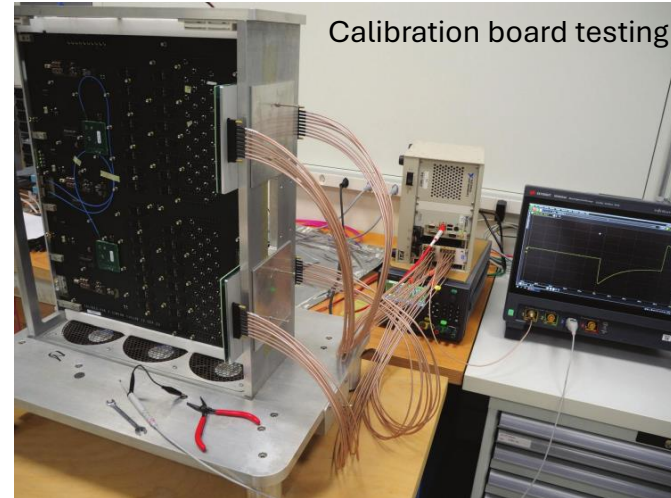
- Outer Cylinder (OC) has been delivered and assembled at CERN
  - Polymoderator and first two barrels inserted
- Surface integration facility at CERN coming together





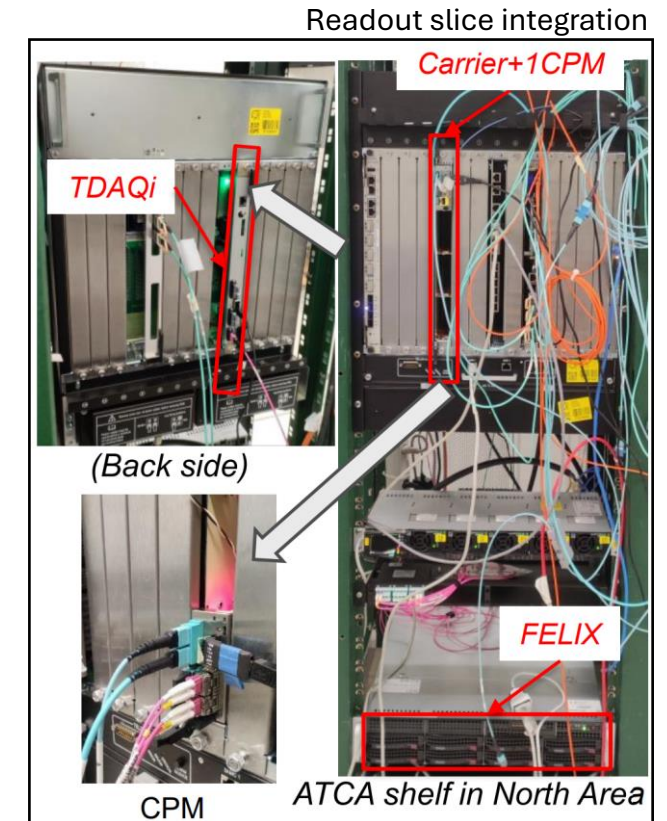
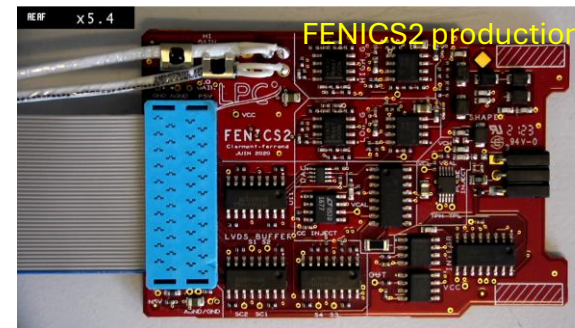
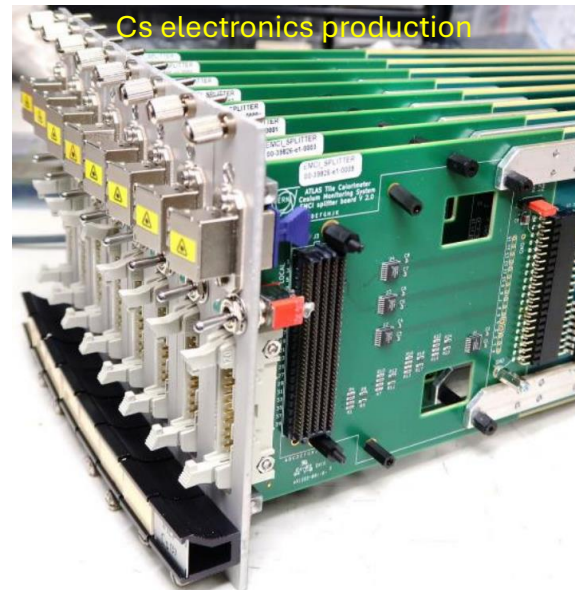
# LAr Calorimeter

- Upgrade of readout electronics
- On detector
  - Front end ASICs in production with excellent test results
  - Final prototype (v2.5) of FEB2 board in hand
    - Initial tests show excellent analogue performance
    - Mini-series being produced now for important half-crate test (by end of year)
  - Calibration board prototypes also in hand and being tested
- Off detector
  - Finalising routing of signal processor board (LASP)
    - First prototypes in March 2025
  - Timing system pre-prototypes (LATS) full assembled and being tested



# Tile Calorimeter

- Upgrade of readout electronics
- On detector
  - Production and testing of replacement PMTs proceeding well
  - FE board (FENICS2) production running well
  - Daughter board prototypes under test and preproduction starting
- Off detector
  - Compact processing module (CPM) v2 fully validated
  - Successful integration of readout slice during last testbeam
- Calibration
  - All electronics parts have entered production





# Muons

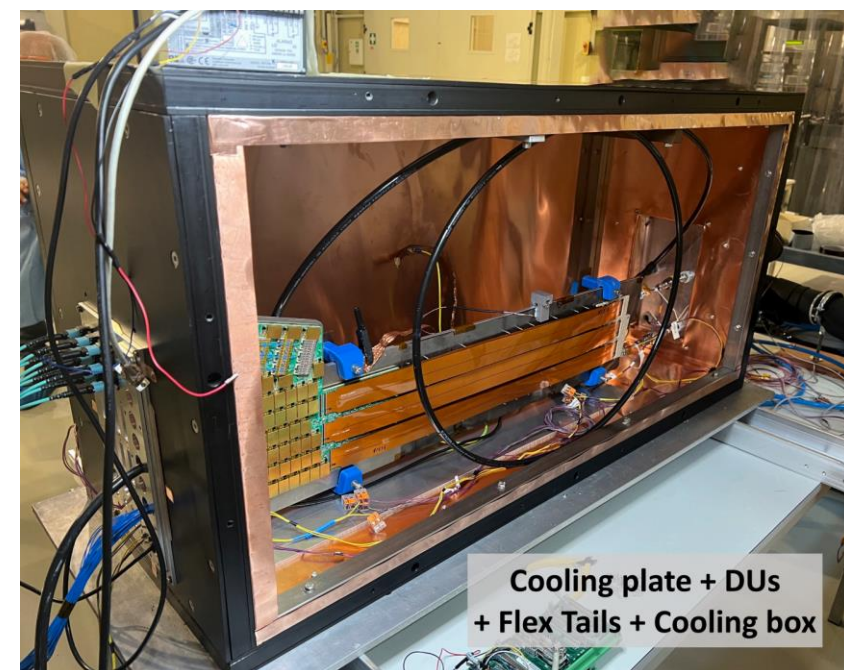
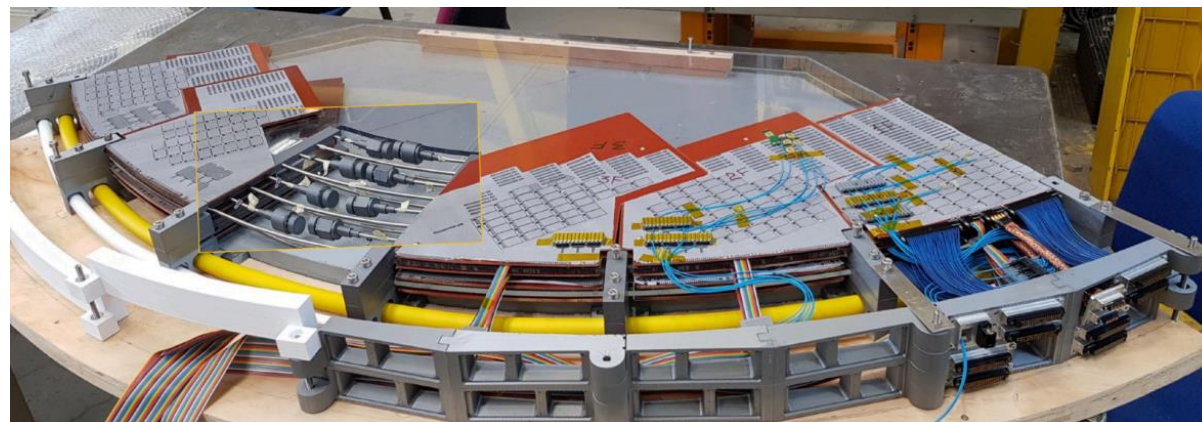
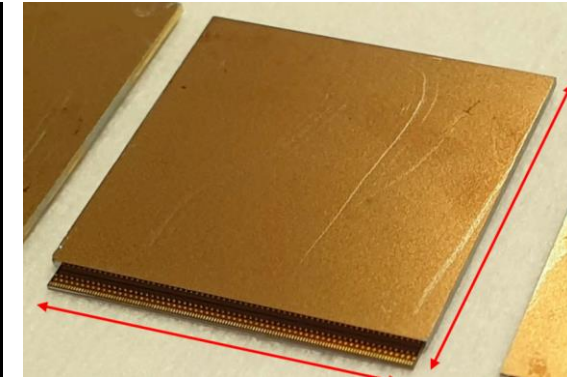
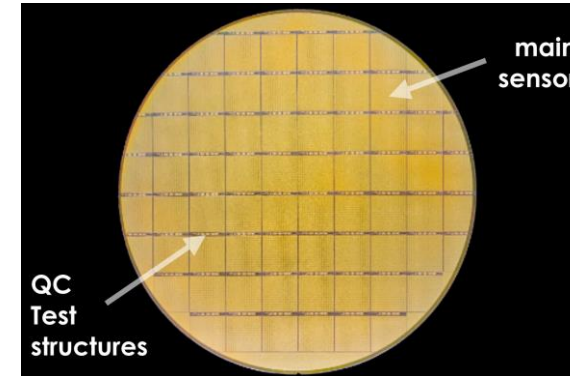
- Electronics upgrades of MDT, RPC & TGC to cope with Phase-II trigger and readout requirements
  - MDT electronics all in final design, heading towards production
  - Full RPC readout chain tests progressing
  - TGC electronics ASIC production complete, board production in progress
- New RPC and sMDT in inner barrel layer
  - RPC gas leak found during production has been extensively studied an alternative solution developed, tested and validated
  - sMDT production is complete





# HGTD

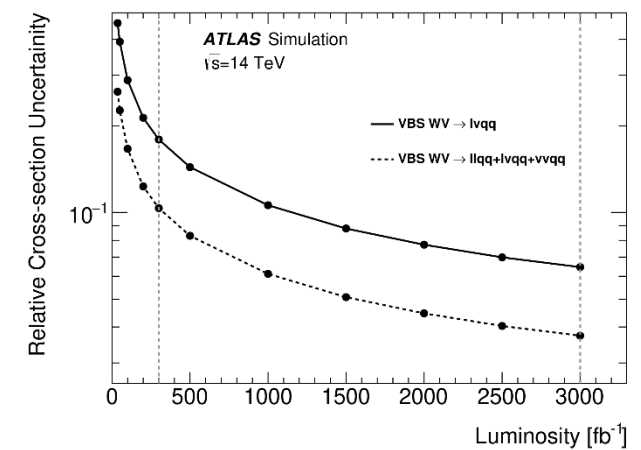
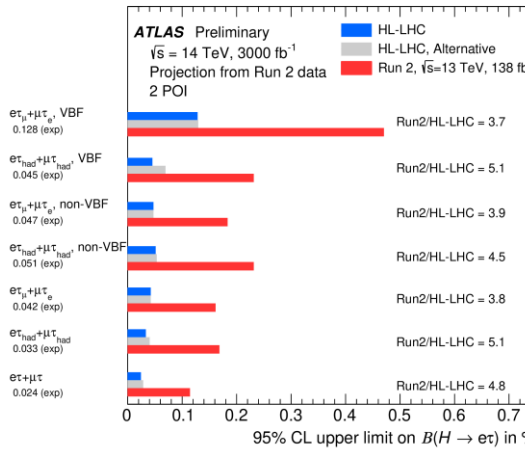
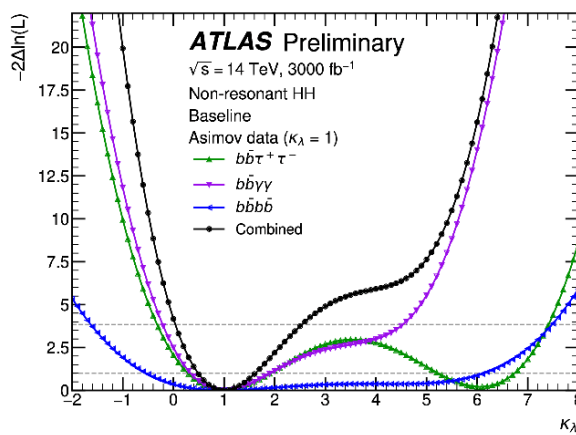
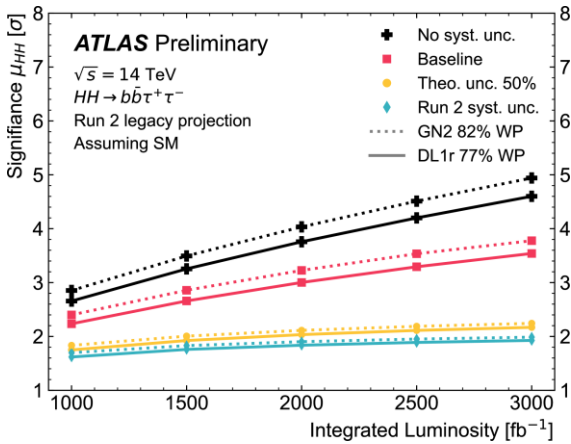
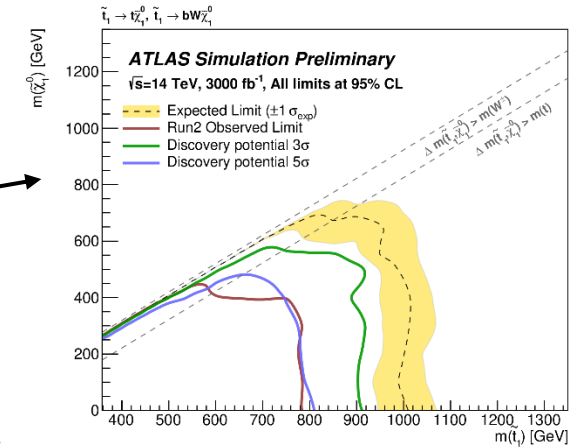
- Pixel detector with coarse spatial resolution but precision timing
- LGAD sensor & readout ASICs tested extensively
  - Sensor and ASIC production imminent
- Extensive testing and simulation performed on hybridised modules
  - Expect to start pre-production soon with unthinned sensors following hybridisation studies
- Excellent progress on services and fibre mock-ups
- Demonstrator tests ongoing



# Upgrade Physics

- Many physics studies for HL-LHC are in the process of being updated for European Strategy Update
- Huge range of physics goals for ATLAS @ HL-LHC
  - Di-Higgs, Higgs couplings, rare Higgs decays, VBS, BSM ...

ATL-PHYS-PUB-2024-001



ATL-PHYS-PUB-2024-016

ATL-PHYS-PUB-2022-053

ATL-PHYS-PUB-2022-054

ATL-PHYS-PUB-2022-018



# Conclusions

---

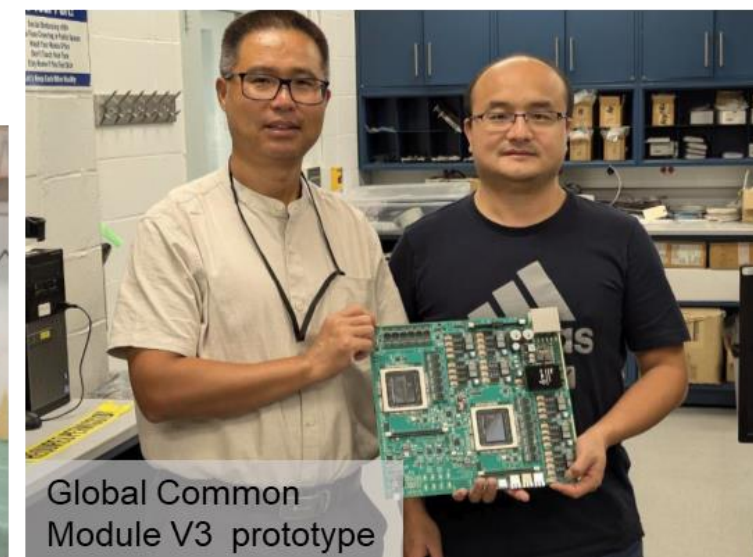
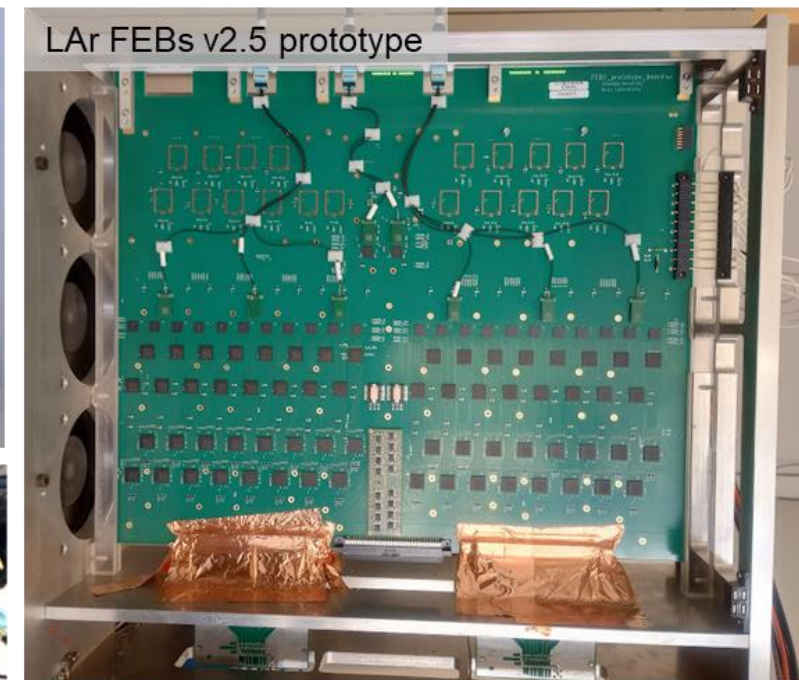
- Huge amount of activity ongoing to upgrade the detector for HL-LHC
  - All new Inner Tracker, fully upgraded calorimeter readout, new muon chambers, new high precision timing layer, new trigger and DAQ systems
- Facing, and traversing, a number of challenging technical problems that have led to delays in our schedule
- Currently schedule has at least 6 months of float for all upgrade projects
- Delivering the upgrade on time for the HL-LHC start is the highest priority for the collaboration





During October ATLAS Week we organised visits to various upgrade sites at CERN (150 participants)





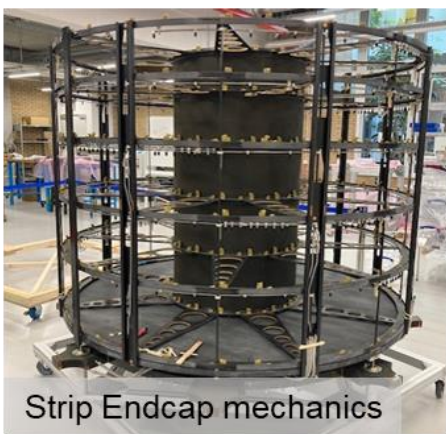




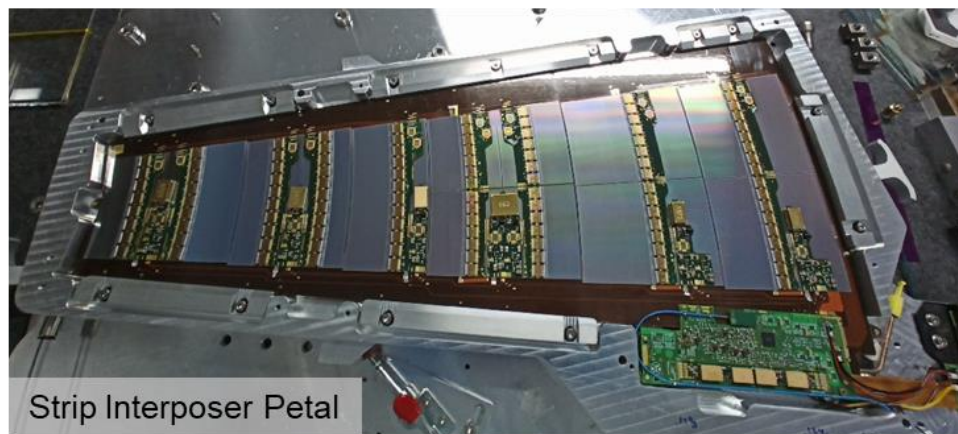
CO2 plant SR1



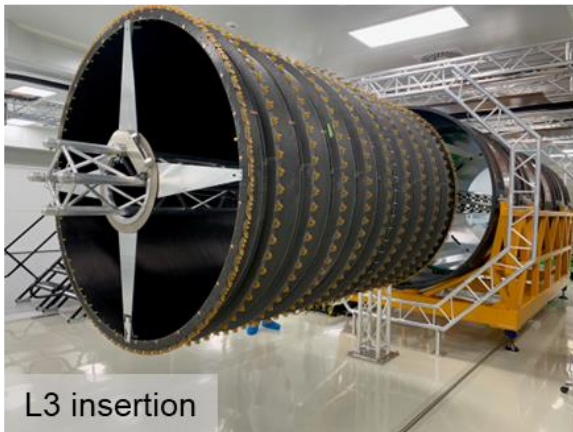
Pixel ASIC probing



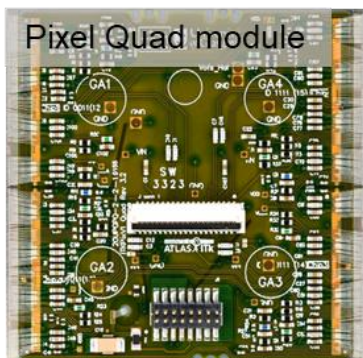
Strip Endcap mechanics



Strip Interposer Petal



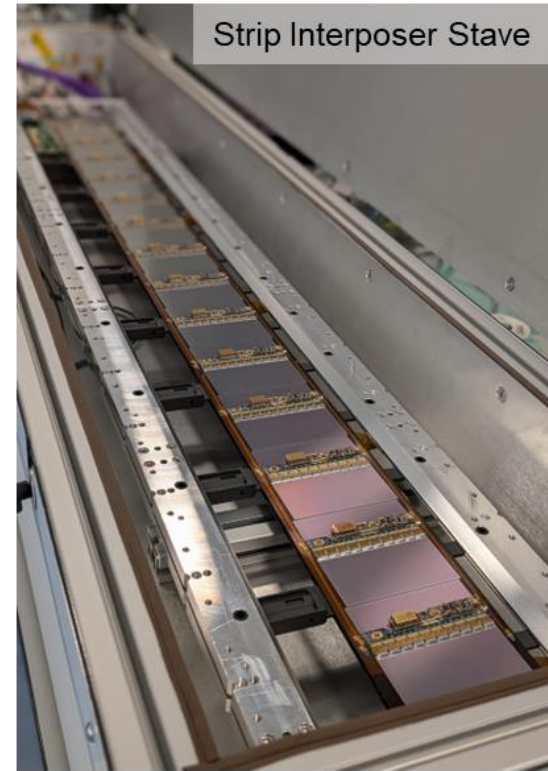
L3 insertion



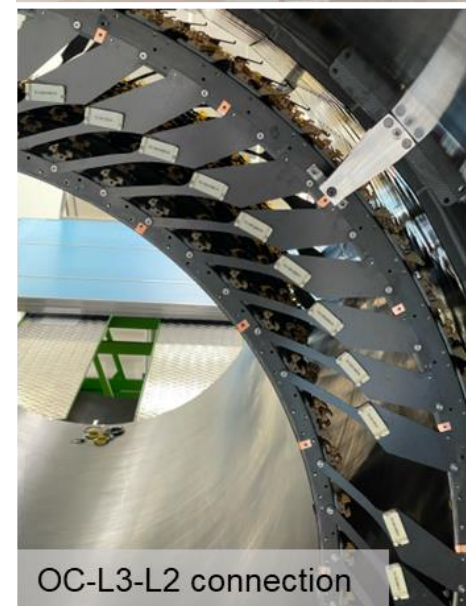
Pixel Quad module



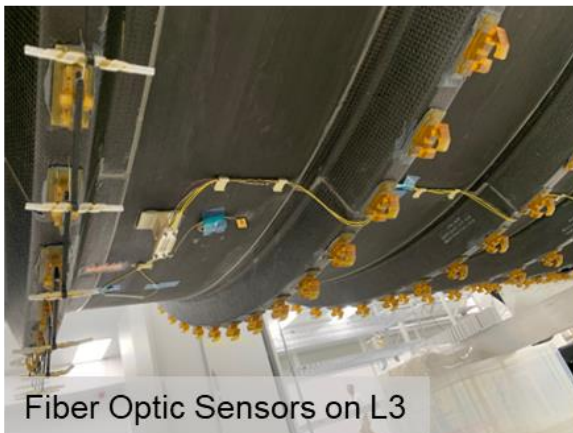
Pixel Inclined Half-rings



Strip Interposer Stave



OC-L3-L2 connection



Fiber Optic Sensors on L3



Strip Interlock in SR1